

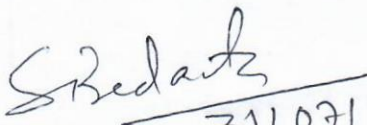
**Technical Comparison of Tender No. C-002064-PH1501-18-19 for  
Diamond Scriber & Sputtering Target**

Company Name			Arcom Enterprise s	Jagatek Corp.	Otto ChemiePv t. Ltd.	RASHMI TA TRADER S
S/N	Item Name	Specification	Comply?	Comply?	Comply?	Comply?
1	Diamond Scriber	Precision Manual Wafer Cutter with Diamond Scriber for Single Crystal Substrate and Glass - SYJ- DS100-LD.	Didn't Quote	Didn't Quote	Didn't Quote	Didn't Quote
2	Iron, (Fe) Sputtering Target	Fe Target 2" dia x 0.75mm thickness, purity 99.95%,	Yes	Yes	Yes	Yes
3	Si with 300nmSiO <sub>2</sub> layer	Thermal Oxide Wafer: 300 nm SiO <sub>2</sub> Layer on Si (100), 4" dia x 0.50 mm thick, N- type, 1SP R:1-10 ohm cm Roughness<5A	Yes	Yes	Yes	Yes
4	Si with 300nmSiO <sub>2</sub> layer	Thermal Oxide Wafer: 300 nm SiO <sub>2</sub> Layer on Si (100), 4" dia x 0.525 mm thick, P-type, 1SP R:1-10 Ohm cm. Roughness < 5 A	Yes	Yes	Yes	Yes
5	Cobalt, (Co) sputtering target	Co Target 2" dia x 1mm thickness, purity 99.95%	Yes	Yes	Yes	Yes

**Recommendation:**

In this e-tender process four companies participated. All these parties have quoted for the sputtering targets (i.e. Items No 2 to 5) and are technically qualifying.

None of them quoted for Diamond Scriber. I would like to remove the Diamond scriber from the procurement. Except Diamond scriber, other four mentioned items (sputtering targets) may kindly be procured from the L1 party.

  
 Dr. Subhankar Bedanta 31/07/2019.  
 Indenting officer  
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